



**Spec No.: DS70-2001-025** Effective Date: 06/17/2016

Revision: E

**LITE-ON DCC** 

**RELEASE** 

BNS-OD-FC001/A4



## 1. DESCRIPTION

#### 1.1 Features

- Isolation voltage between input and output V<sub>iso</sub>: 5,000V<sub>rms</sub>
- 6pin DIP photocoupler, triac driver output
- High repetitive peak off-state voltage  $V_{\text{DRM}}$ : Min. 600V
- High critical rate of rise of off-state voltage( dV/dt : MIN. 1000V / µs )
- Dual-in-line package: MOC3050, MOC3051, MOC3052, MOC3053
- Wide lead spacing package: MOC3050M, MOC3051M, MOC3052M, MOC3053M
- Surface mounting package: MOC3050S, MOC3051S, MOC3052S, MOC3053S
- Tape and reel packaging: MOC3050S-TA, MOC3051S-TA, MOC3052S-TA, MOC3053S-TA MOC3050S-TA1, MOC3051S-TA1, MOC3052S-TA1, MOC3053S-TA1
- Safety approval
  - UL 1577, Cert. No.E113898

CSA CA5A, Cert. No. 1020087 (CA 91533-1)

FIMKO EN/IEC 60950-1, EN/IEC 60065; Cert. No.NCS/FI 24426 M3

VDE DIN EN60747-5-2, Cert. No. 40015248

CQC GB4943.1-2011/ GB8898-2011

- **RoHS Compliance** 
  - All materials be used in device are followed EU RoHS directive (No.2002/95/EC).
- MSL class1

#### 1.2 Applications

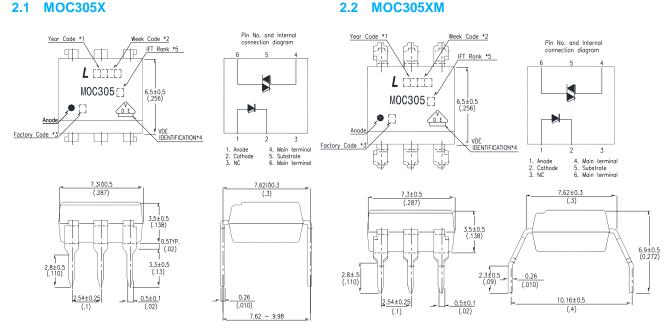
- **AC Motor Drives**
- **AC Motor Starters**
- E.M. Contactors
- Lighting Controls
- Solenoid/Valve Controls
- Solid State Relays
- Static Power Switches
- **Temperature Controls**

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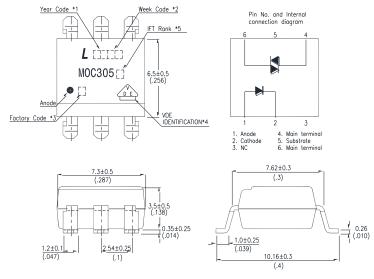


## 2. PACKAGE DIMENSIONS

#### MOC305X



#### 2.3 MOC305XS



#### Notes:

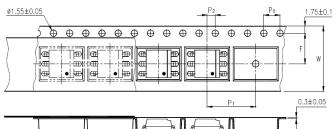
- 1. Year date code.
- 2. 2-digit work week.
- 3. Factory identification mark shall be marked (W: China-CZ, Y: Thailand)
- 4. VDE option
- 5. I<sub>FT</sub> rank
- \* Dimensions are in Millimeters and (Inches).

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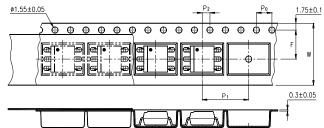


## 3. TAPING DIMENSIONS

## 3.1 MOC305XS-TA



#### 3.2 MOC305XS-TA1



Description	Symbol	Dimension in mm (inch)
Tape wide	W	16±0.3 (0.63)
Pitch of sprocket holes	P <sub>0</sub>	4±0.1 (0.15)
Distance of compartment	F	7.5±0.1 (0.295)
	P <sub>2</sub>	2±0.1 (0.079)
Distance of compartment to compartment	P <sub>1</sub>	12±0.1 (0.472)

#### 3.3 Quantities Per Reel

Package Type	MOC305XS series	
Quantities (pcs)	1000	

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## 4. RATING AND CHARACTERISTICS

#### 4.1 Absolute Maximum Ratings at Ta=25°C

	Parameter	Symbol	Rating	Unit	
Forward Current		I <sub>F</sub>	50	mA	
laasat	Reverse Voltage	$V_{R}$	6	V	
Input	Junction Temperature	Τ <sub>J</sub>	125	°C	
	Power Dissipation	Р	100	mW	
	Off-State Output Terminal Voltage	$V_{DRM}$	600	V	
Peak Repetitive Surge Current			4	А	
Output	( PW=1ms, 120pps )	I <sub>TSM</sub>	1	A	
	Junction Temperature	TJ	125	°C	
	Collector Power Dissipation	Pc	300	mW	
	Total Power Dissipation	P <sub>tot</sub>	330	mW	
1.	Isolation Voltage	V <sub>iso</sub>	5000	$V_{rms}$	
	Operating Temperature	$T_{opr}$	-40 ~ +100	°C	
	Storage Temperature	$T_{stg}$	-55 ~ +150	°C	
2.	Soldering Temperature	T <sub>sol</sub>	260	°C	

1. AC For 1 Minute, R.H. =  $40 \sim 60\%$ 

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.
- 2. For 10 Seconds

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#### 4.2 ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

Parameter		Symbol	Min.	Тур.	Max.	Unit	Test Condition	
Forward Voltage		$V_{F}$	_	1.15	1.5	V	I <sub>F</sub> =20mA	
Input	Reverse Current		I <sub>R</sub>	_	0.05	10	μА	V <sub>R</sub> =6V
	Peak Blocking Current, Either Direction  Peak On-State Voltage, Either Direction		I <sub>DRM</sub>	_	10	100	nA	V <sub>DRM</sub> = 600V
Output			V <sub>TM</sub>	_	1.7	3.0	V	I <sub>TM</sub> =100 mA Peak
Critical rate of Rise 2 Off-State Voltage			dv/dt	1000	_	_	V/μs	Vin=240Vrms
	Led Trigger	MOC3050	3051 I <sub>FT</sub>	_	_	30	mA	Main Terminal
	Current, Current	MOC3051		_	_	15		
Couple	Required to	MOC3052		_	_	10		Voltage = 3V
	Latch Output,	MOC3053		_	_	5		
	Holding Current, Either Direction		I <sub>H</sub>	_	200	_	μΑ	

<sup>\*1.</sup> Test voltage must be applied within dv/dt rating.

<sup>\*2.</sup> This is static dv/dt. Commutating dv/dt is a function of the load-driving thyristor(s) only.

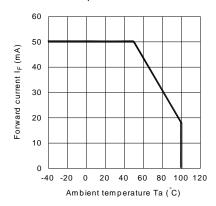
<sup>\*3.</sup> All devices are guaranteed to trigger at an I<sub>F</sub> value less than or equal to max I<sub>FT</sub>. Therefore, recommended operating I<sub>F</sub> lies between max I<sub>FT</sub>, 30 mA for MOC3050, 15 mA for MOC3051, 10 mA for MOC3052, 5 mA for MOC3053, and absolute max I<sub>F</sub> (50mA)



## **CHARACTERISTICS CURVES (TYPICAL PERFORMANCE)**

Fig.1 Forward Current vs.

**Ambient Temperature** 



Temperature

Fig.2 On-state Current vs. Ambient

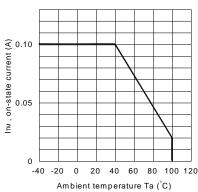


Fig.3 Minimum Trigger Current vs. Ambient Temperature

10 V<sub>P</sub>= 6V Minimum trigger current IFT (mA) R<sub>L</sub>= 100 Ω 8 6 4 2 20 100 Ambient temperature (  $^{\circ}$ C)

Fig.4 Forward Current vs. Forward Voltage

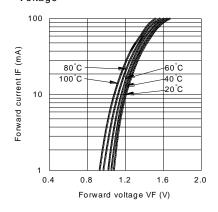


Fig.5 On-state Voltage vs. Ambient Temperature

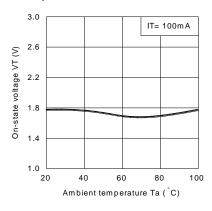
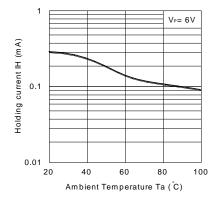


Fig.6 Holding Current vs.

Ambient Temperature



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Fig.7 Repetitive Peak Off-state Current vs. Temperature

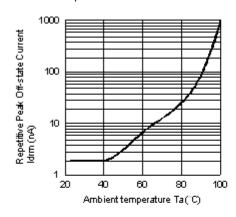
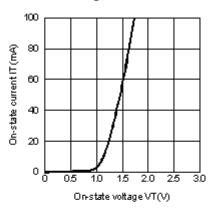
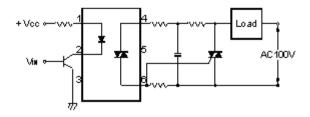


Fig.8 On-state Current vs. On-state Voltage



Basic Operation Circuit Medium/High Power Triac Drive Circuit



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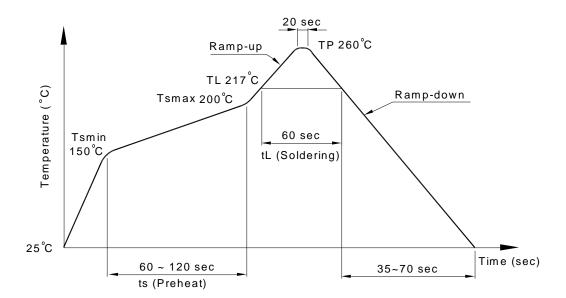


## 6. TEMPERATURE PROFILE OF SOLDERING

## 6.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

Profile item	Conditions			
Preheat				
- Temperature Min (T <sub>Smin</sub> )	150°C			
- Temperature Max (T <sub>Smax</sub> )	200°C			
- Time (min to max) (ts)	90±30 sec			
Soldering zone				
- Temperature (T <sub>L</sub> )	217°C			
- Time (t <sub>L</sub> )	60 sec			
Peak Temperature (T <sub>P</sub> )	260°C			
Ramp-up rate	3°C / sec max.			
Ramp-down rate	3~6°C / sec			



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## 6.2 Wave soldering (JEDEC22A111 compliant)

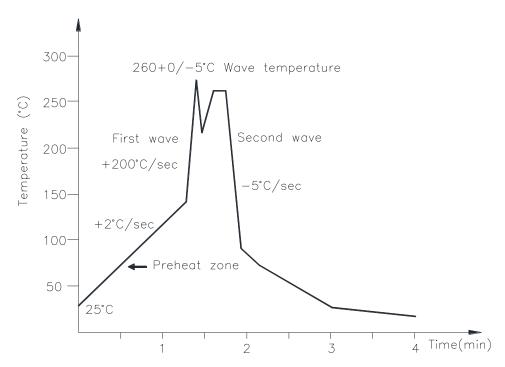
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C

Time: 10 sec.

Preheat temperature:25 to 140°C

Preheat time: 30 to 80 sec.



## 6.3 Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature: 380+0/-5°C

Time: 3 sec max.

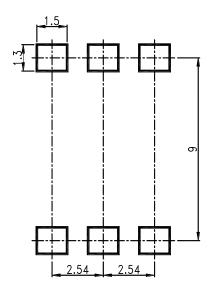
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## 7. RRECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)

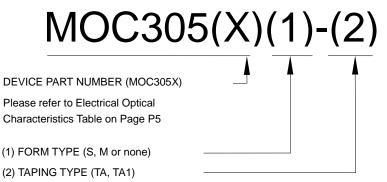
Unit: mm



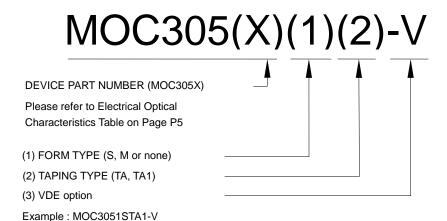
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#### 8. NAMING RULE



Example: MOC3051S-TA1



#### 9. NOTES

- LiteOn is continually improving the quality, reliability, function or design and LiteOn reserves the right to make changes without further notices.
- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.

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## LITEON:

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